

VOLTAGE RANGE: 50 - 1000V

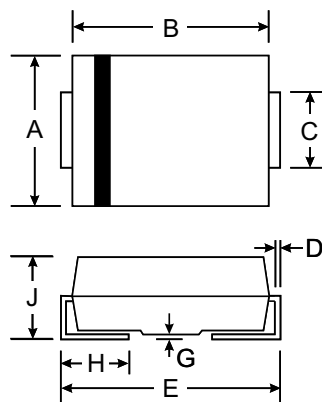
CURRENT: 2.0 A

Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop and High Current Capability
- Ideally Suited for Automated Assembly

Mechanical Data

- Case: SMB(DO-214AA)Molded Plastic
- Case Material - UL Flammability Rating Classification 94V-0
- Terminals: Solder Plated Terminal - Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.093 grams (approx.)



SMB(DO-214AA)		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.70
C	1.91	2.21
D	0.15	0.31
E	5.00	5.59
G	0.10	0.20
H	0.76	1.52
J	2.00	2.62
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	S2A	S2B	S2D	S2G	S2J	S2K	S2M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T _T = 100°C	$I_{(AV)}$	2.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	60							A
Forward Voltage @ I _F = 2.0A	V_{FM}	1.1							V
Peak Reverse Current @ T _A = 25°C @ T _A = 125°C	I_{RM}	5.0 200							μA
Typical Total Capacitance (Note 1)	C_T	30							pF
Typical Thermal Resistance, Junction to Terminal (Note 2)	$R_{\theta JT}$	16							°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150							°C

Notes: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
2. Thermal Resistance Junction to Terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

RATING AND CHARACTERISTIC CURVES S2A THRU S2M

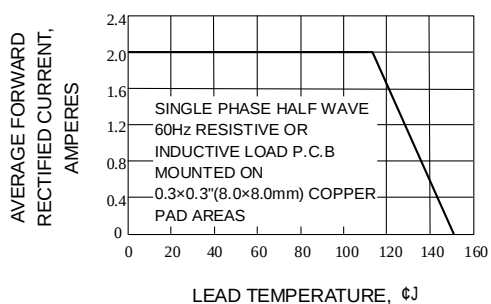


Fig. 1-FORWARD CURRENT DERATING CURVE

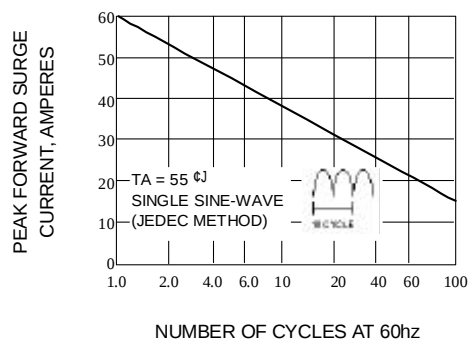


Fig. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

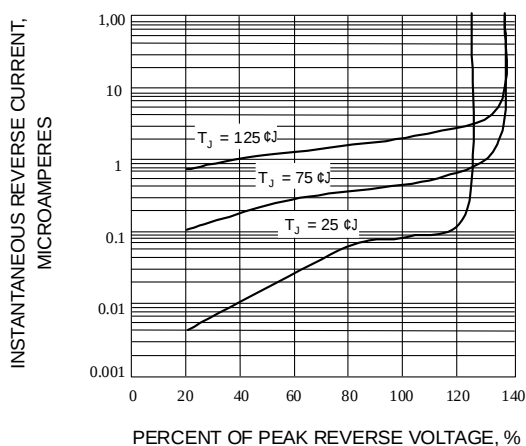


Fig. 3-TYPICAL REVERSE CHARACTERISTICS

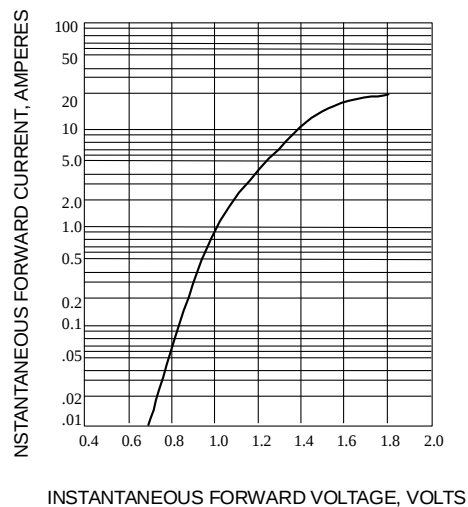


Fig. 4-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

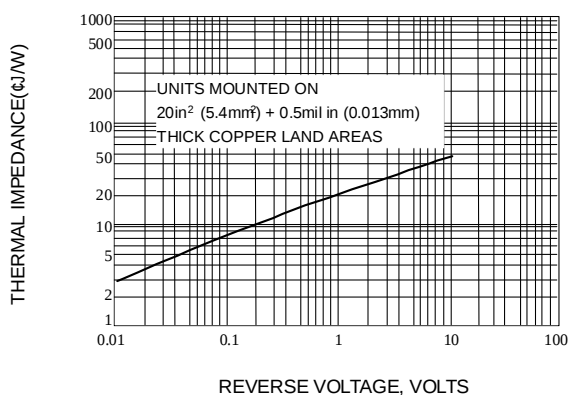


Fig. 5-TRANSIENT THERMAL IMPEDANCE

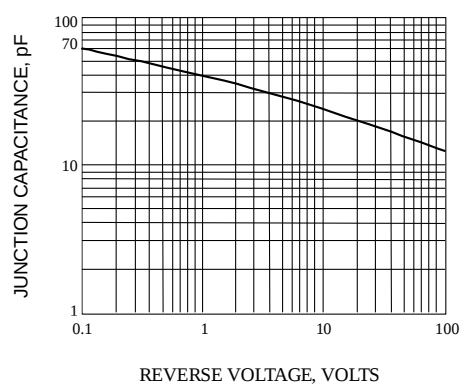


Fig. 6-TYPICAL JUNCTION CAPACITANCE

单击下面可查看定价，库存，交付和生命周期等信息

[>>SUNMATE\(森美特\)](#)